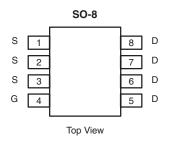


N-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^a	Q _g (Typ.)			
20	0.006 at V _{GS} = 10 V	20 ^e	27.5 nC			
20	$0.007 \text{ at V}_{GS} = 4.5 \text{ V}$	20 ^e	27.5110			



Ordering Information: Si4114DY-T1-E3 (Lead (Pb)-free)

Si4114DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

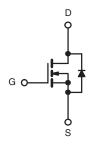
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_q and UIS Tested
- Compliant to RoHS Directive 2002/95/EC



ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

- · Low-Side MOSFET for Synchronous Buck
 - Game Machine
 - PC



N-Channel MOSFET

Parameter	Symbol	Limit	Unit		
			20	Offic	
Drain-Source Voltage		V _{DS}		V	
Gate-Source Voltage		V_{GS}	± 16		
	T _C = 25 °C		20 ^e		
Continuous Drain Current (T _{.I} = 150 °C)	T _C = 70 °C	1 . [18.2		
Continuous Brain Gunerit (1) = 130 °C)	T _A = 25 °C	l _D	15.2 ^{b, c}		
	T _A = 70 °C	1	12.1 ^{b, c}	Α	
Pulsed Drain Current		I _{DM}	50		
Continuous Source-Drain Diode Current	T _C = 25 °C	I _S	5.1		
Continuous Source-Drain Diode Current	T _A = 25 °C		2.2 ^{b, c}		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	30		
Avalanche Energy		E _{AS}	45	mJ	
	T _C = 25 °C		5.7		
Marian and David Displacetion	T _C = 70 °C	1 6	3.6	w	
Maximum Power Dissipation	T _A = 25 °C	P _D	2.5 ^{b, c}	VV	
	T _A = 70 °C		1.6 ^{b, c}		
Operating Junction and Storage Temperature	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R_{thJA}	39	50	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	18	22	O/ VV		

Notes:

- a. Based on $T_C = 25$ °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 85 °C/W.
- e. Package limited.

Si4114DY

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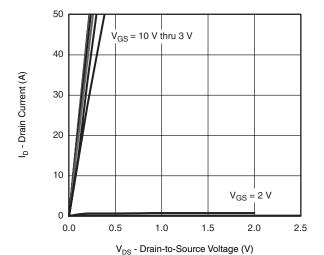
SPECIFICATIONS $T_J = 25 ^{\circ}C$, Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	Symbol	rest conditions	IVIIII.	Typ.	IVIAA.	Onit	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	20			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	<u> </u>		19		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = 250 \mu A$		- 5.3			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu\text{A}$	1.0	0.0	2.1	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 16 \text{ V}$			± 100	nA	
g-	400	V _{DS} = 20 V, V _{GS} = 0 V	1			μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 20 V, V _{GS} = 0 V, T _J = 55 °C			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V, } V_{GS} = 10 \text{ V}$	30			Α	
		V _{GS} = 10 V, I _D = 10 A		0.0049	0.006		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V, } I_D = 7 \text{ A}$		0.0056	0.007	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 10 V, I _D = 10 A		55		S	
Dynamic ^b	-			1		<u> </u>	
Input Capacitance	C _{iss}			3700		pF	
Output Capacitance	C _{oss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		745			
Reverse Transfer Capacitance	C _{rss}			315			
Total Cata Charge	0	$V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$		62	95		
Total Gate Charge	Q _g			27.5	42	nC	
Gate-Source Charge	Q_{gs}	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		8.0			
Gate-Drain Charge	$Q_{ m gd}$			6.0			
Gate Resistance	R_g	f = 1 MHz	0.15	0.7	1.4	Ω	
Turn-On Delay Time	t _{d(on)}			30	55		
Rise Time	t _r	V_{DD} = 10 V, R_L = 2 Ω		13	25	- ns	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		60	100		
Fall Time	t _f			30	55		
Turn-On Delay Time	t _{d(on)}			13	25	113	
Rise Time	t _r	V_{DD} = 10 V, R_L = 2 Ω		9	18	- -	
Turn-Off Delay Time	t _{d(off)}	$I_D\cong 5$ A, V_{GEN} = 10 V, R_g = 1 Ω		38	65		
Fall Time	t _f			8	16		
Drain-Source Body Diode Characteristic	cs						
Continuous Source-Drain Diode Current	I _S	$T_C = 25 ^{\circ}C$			5.1	^	
Pulse Diode Forward Current ^a	I _{SM}				50	A	
Body Diode Voltage	V_{SD}	I _S = 2 A		0.71	1.1	V	
Body Diode Reverse Recovery Time	t _{rr}			26	50	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 10 A, dl/dt = 100 A/μs, T _{.I} = 25 °C		16	30	nC	
Daviagas Dasaviaga Fall Times	t _a	$_{1F} - 10 \text{ A}, \text{ u/ut} = 100 \text{ A/}\mu\text{s}, \text{ 1J} = 25 ^{\circ}\text{C}$		13		ns	
Reverse Recovery Fall Time	٠a			10		nc	

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

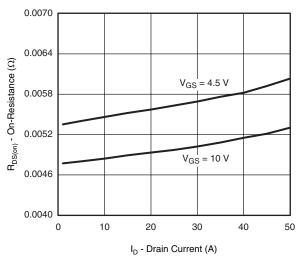
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



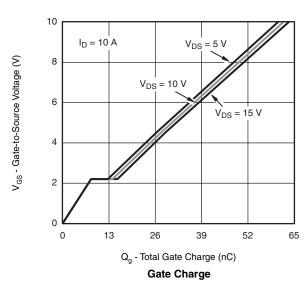
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

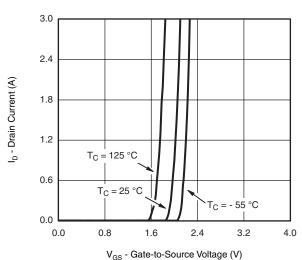


Output Characteristics

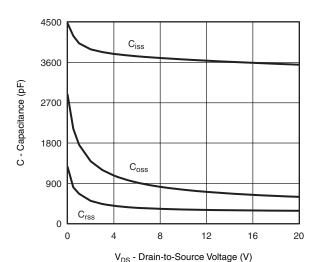


On-Resistance vs. Drain Current and Gate Voltage

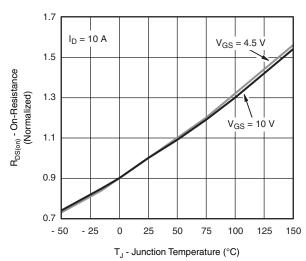




Transfer Characteristics



Capacitance



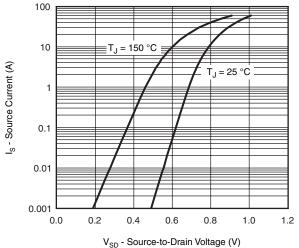
On-Resistance vs. Junction Temperature

Si4114DY

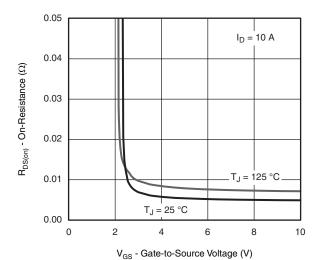
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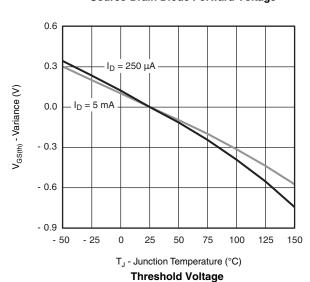
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

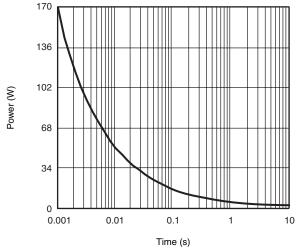


Source-Drain Diode Forward Voltage

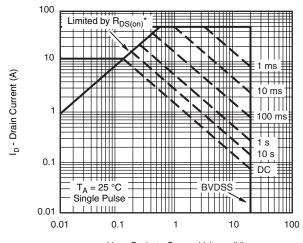


On-Resistance vs. Gate-to-Source Voltage





Single Pulse Power, Junction-to-Ambient

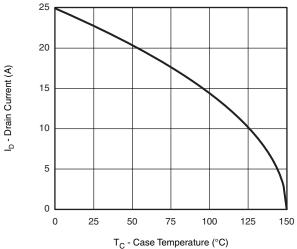


 $\rm V_{DS}$ - Drain-to-Source Voltage (V) * $\rm V_{DS}$ > minimum $\rm V_{GS}$ at which $\rm R_{DS(on)}$ is specified

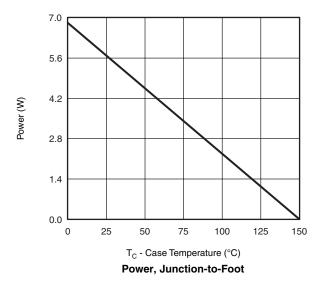
Safe Operating Area, Junction-to-Ambient

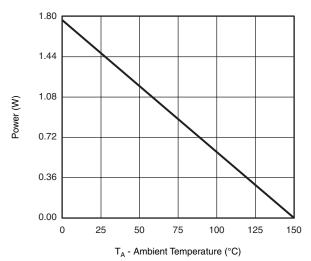


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Current Derating*



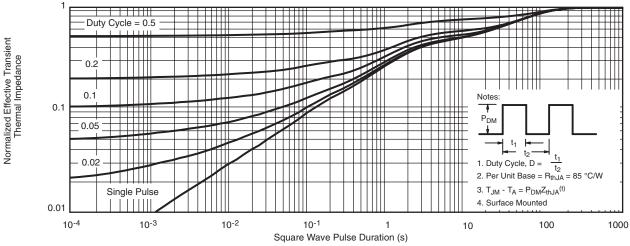


Power, Junction-to-Ambient

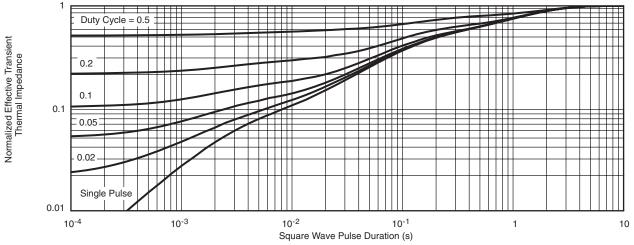
^{*} The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







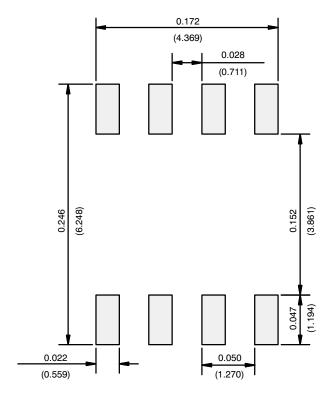
	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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